

**Electronic Supplementary Information (ESI) for:**

**Acceptor defect participating magnetic exchange in  
ZnO:Cu nanocrystalline film: defect structure  
evolution, Cu-N synergetic role and magnetic control**

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**Graphic and Tabular Lists**

**Figure S1** The TEM images of 8% Cu-doped ZnO NCs including CuO secondary phase.

**Table S1** Details of the preparing method, copper doping amount, and magnetic parameters for different ZnO:Cu sample types in terms of powder and film.

**Figure S2** STEM and EDX results of a single N-capped ZCO0.8 nanoparticle.

**Figure S3** XRD data of as-prepared ZnO:Cu NCs (a) before and (b) after amine bath treatment.

**Table S2** Detailed XRD refinement result from Rietveld Analysis Program.

**Figure S4** EELS reference signals collected from home-made pure-phase Cu, Cu<sub>2</sub>O and CuO nanoparticles.

**Figure S5** (a) Dopant concentration-dependent excitonic absorption spectra. (b) An absorption spectral comparison of ZCO0.8 samples before and after amine bath treatment.

**Figure S6** The Cu  $L_{3,2}$  core-loss EELS comparison between amine-bath-untreated

lightly-doped (0.8%) and heavily-doped (2.0%) samples.

**Figure S7** A series of FT-IR spectra recorded from amine-bath-treated, amine-bath-untreated and amine-annealed ZCO4.0 NCs.

**Figure S8** The corresponding variation of C 1s XPS binding environment in ZCO4.0 NCs processed by different conditions.

**Figure S9** Room-temperature ESR signal of free diluted Cu<sup>2+</sup> ions in chloroform solution.

**Figure S10** The comparison of 300 K PL spectra recorded from N-capped ZnO NC film before and after vacuum treatment.

**Figure S11** 300 K magnetization from OA-capped 0.2% Cu-doped ZnO colloidal NCs, a spin-coated NC film without OA capping, annealed at 400°C, and the same NC film with OA capping.

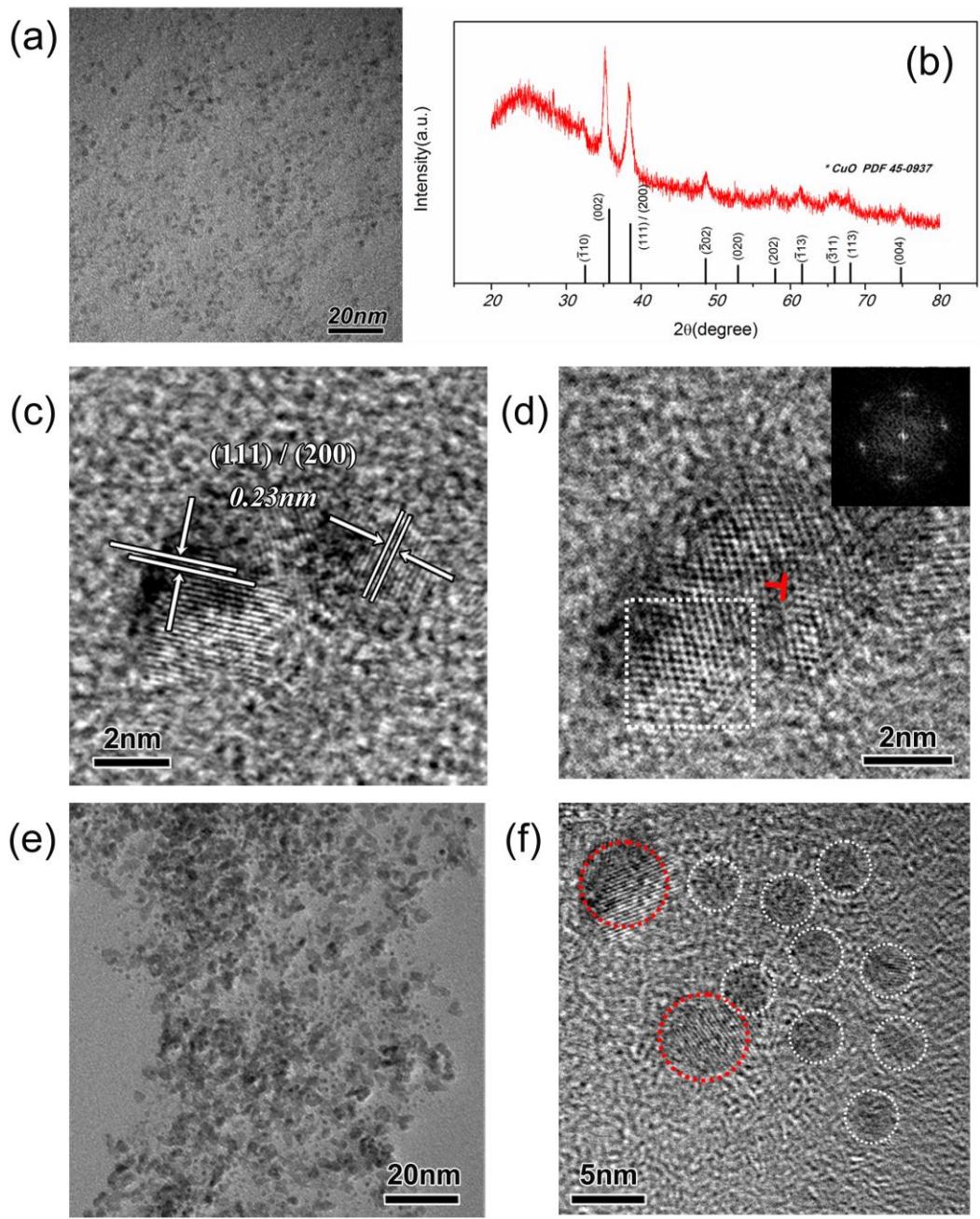
**Figure S12** 300 K ESR signals of pure ZnO NCs (without OA capping) before and after aggregation.

**Figure S13** 300 K magnetization contrast between spin-coated ZnO NC film before and after OA capping, annealed at 400°C.

**Figure S14** The effect of amine-capping on texture in 400°C annealed 0.2% Cu-doped ZnO nanocrystalline film.

**Figure S15** The effect of amine-capping on grain-size in 400°C annealed 0.2% Cu-doped ZnO nanocrystalline film.

**Figure S16** The effect of amine-capping on amorphous layer in 400°C annealed 0.2% Cu-doped ZnO nanocrystalline film.



**Fig. S1** (a), (b), and (c) represent TEM image, XRD profile, and HRTEM image of home-made pure CuO NCs, respectively. For comparison, highly-doped ZnO:Cu (8%) NCs including CuO secondary phase are shown in (d-f). Among them, (e) is survey TEM, (d) and (f) are the magnified images. Small particles circled by white dashed-line in (f) indicate CuO NCs, while red ones represent doped ZnO NCs.

**Table S1.** Details of the preparing method, copper doping amount, and magnetic parameters (saturated magnetization  $M_s$ , coercivity  $H_c$ , and Curie temperature  $T_c$ ) for different ZnO:Cu sample types in terms of powder and film.

Material type	Preparing method	Doping amount (at.%)	$M_s$ ( $\mu_B/\text{Cu}$ )	$H_c$ (Oe)	$T_c$ (K)	Ref.
Powder <sup>a</sup>	CVD <sup>b</sup>	2.2%	1.48	-	380	1
	CVD	1.37%	0.2	50	-	2
	sol-gel	5%	$2.6 \times 10^{-4}$	-	-	3
	sol-gel	2%	PM <sup>g</sup>	0	-	4
	sol-gel	3%	0.4	-	-	5
	hydrothermal	0.5%	0.47	47	-	6
	hydrothermal	1%	0.001	1500	-	7
	thermal diffusion	4.9%	0.074	-	-	1
	thermal diffusion	< 1%	1.39	>1000	-	8
	vapor transport	0.5%	0.116	-	-	9
	vapor transport	1%	0.2	100	300	10
	coprecipitation	5%	$7.3 \times 10^{-6}$	-	300	11
Film	FCVA <sup>c</sup>	2.4%	0.037	<1000	-	14
	FCVA (N <sub>2</sub> O annealing)	1.3%	0.73	81	-	15
	FCVA (Zn annealing)	1.3%	0.4	-	-	16
	PLD <sup>d</sup>	< 5%	0.18	-	-	17
	PLD	5%	0.81	100	320	18
	PLD	5%	1.45	1875	-	19

PLD	2%	0.75	-	-	20
PLD	2%	0.75	61	300	21
PLD	2%	0.5	260	750	22
PLD	1%	0.4	-	400	23
PVD <sup>e</sup>	5%	0.14 <sup>h</sup>	100	-	24
MS <sup>f</sup>	< 3%	1.62	168	350	25
MS	2%	1.8	-	350	26
MS	5%	0.52	-	360	27
MS	2.5%	0.25	-	300	28
MS	0.6%	1.6	50	300	29
hydrothermal	2%	0.4	-	-	30
RF plasma deposition	8%	0.03	-	-	31

**Note:**

a: including any shape nanopowders or substrate-supported nanostructures

b: chemical vapor deposition

c: filtered cathodic vacuum arc technique

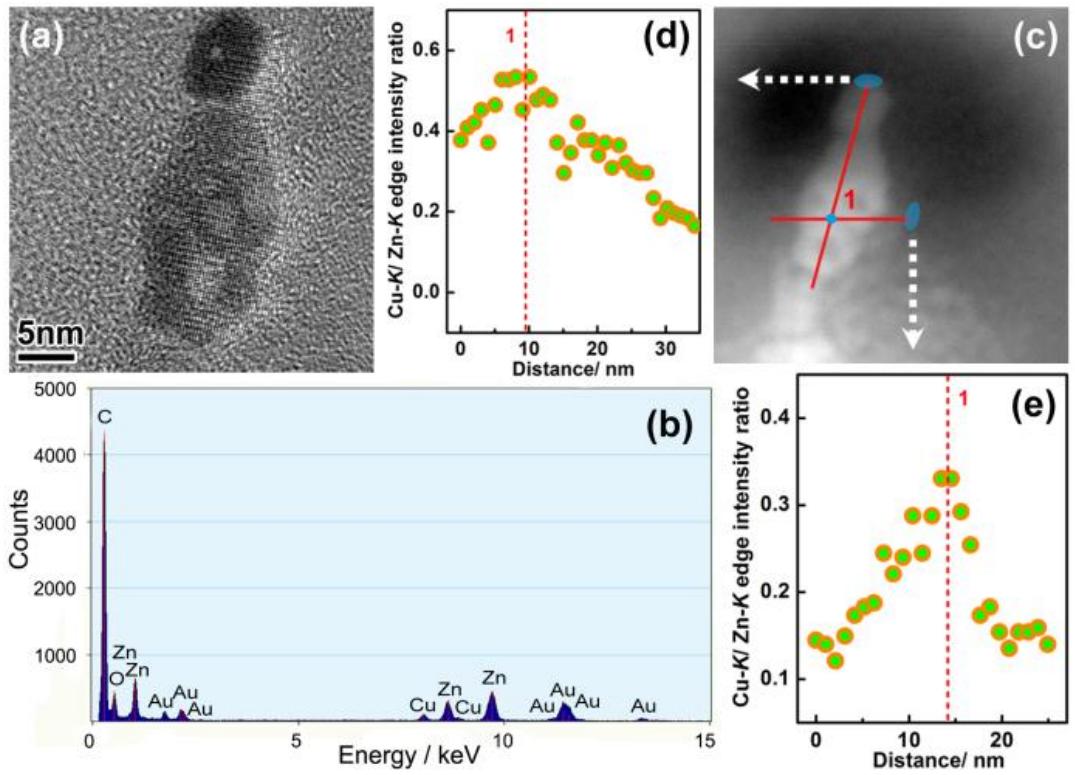
d: pulsed laser deposition

e: physical vapor deposition

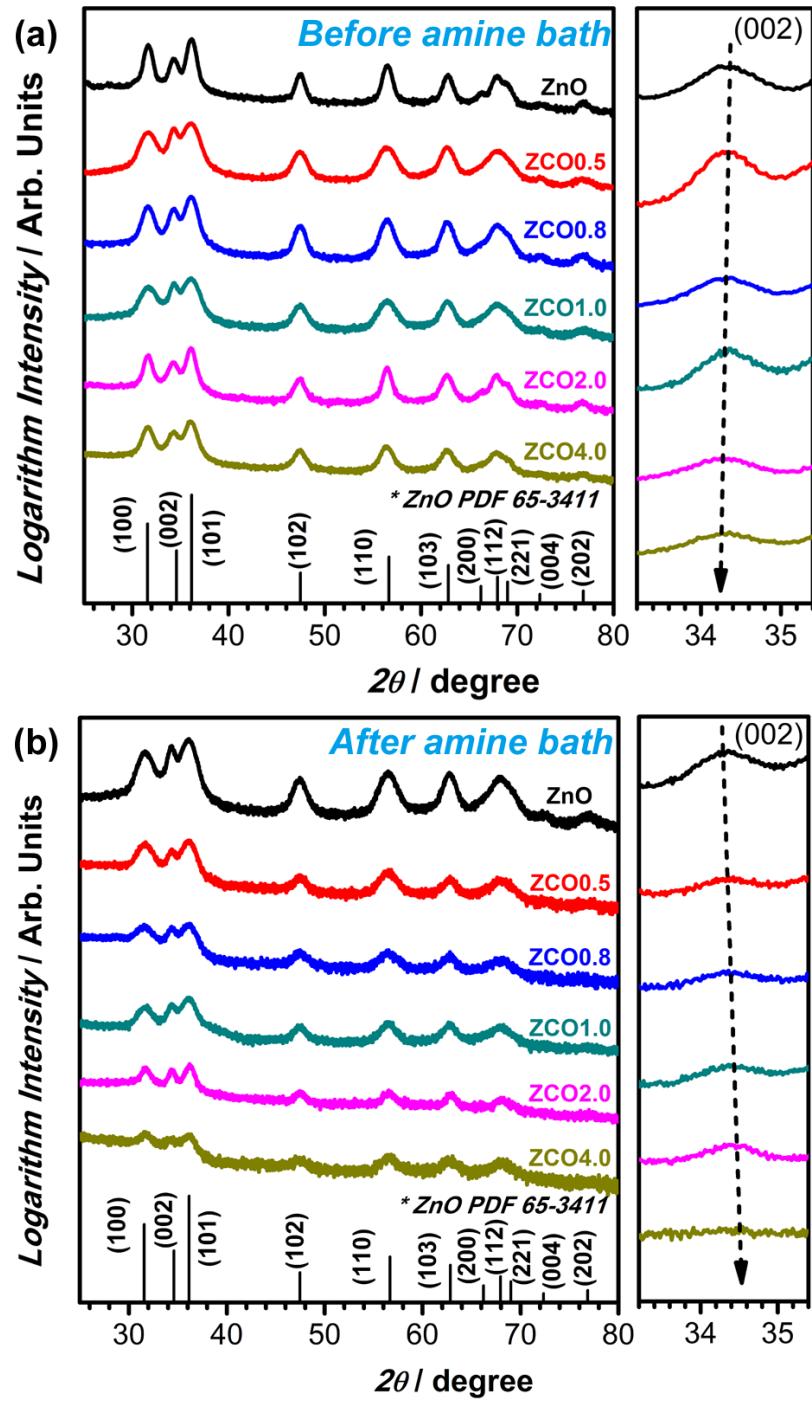
f: magnetron sputtering

g: paramagnetism

h: emu/cm<sup>3</sup> (unit)



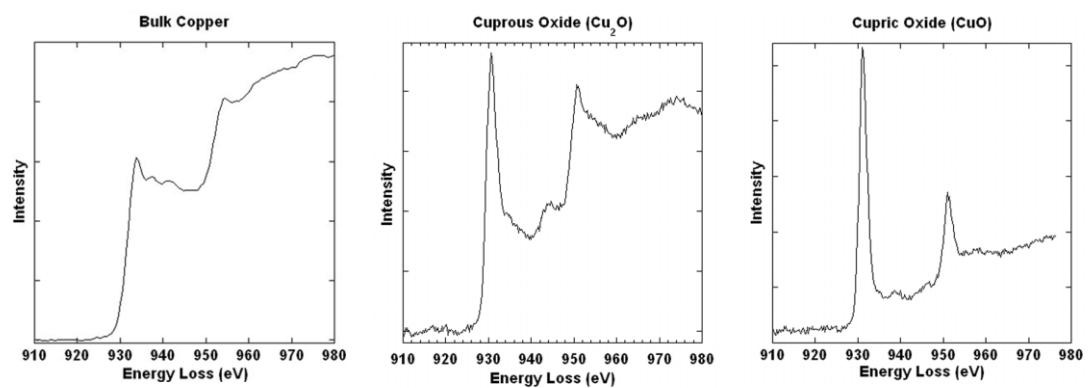
**Fig. S2** STEM and EDX results of a single N-capped ZCO0.8 nanoparticle. (a) Original HRTEM image. (b) EDX spectrum suggesting the presence of Zn, Cu and O elements. (c) Corresponding HAADF-STEM image. The observed contrast difference corresponds to the dopant distribution inhomogeneity. (d-e) Line-scan EDX results of Cu  $K$ -edge/ Zn  $K$ -edge intensity ratio from different scan directions. The fact that the maximum intensity ratio is around the middle of the NC, could be well understood because the sample thickness there is the largest.



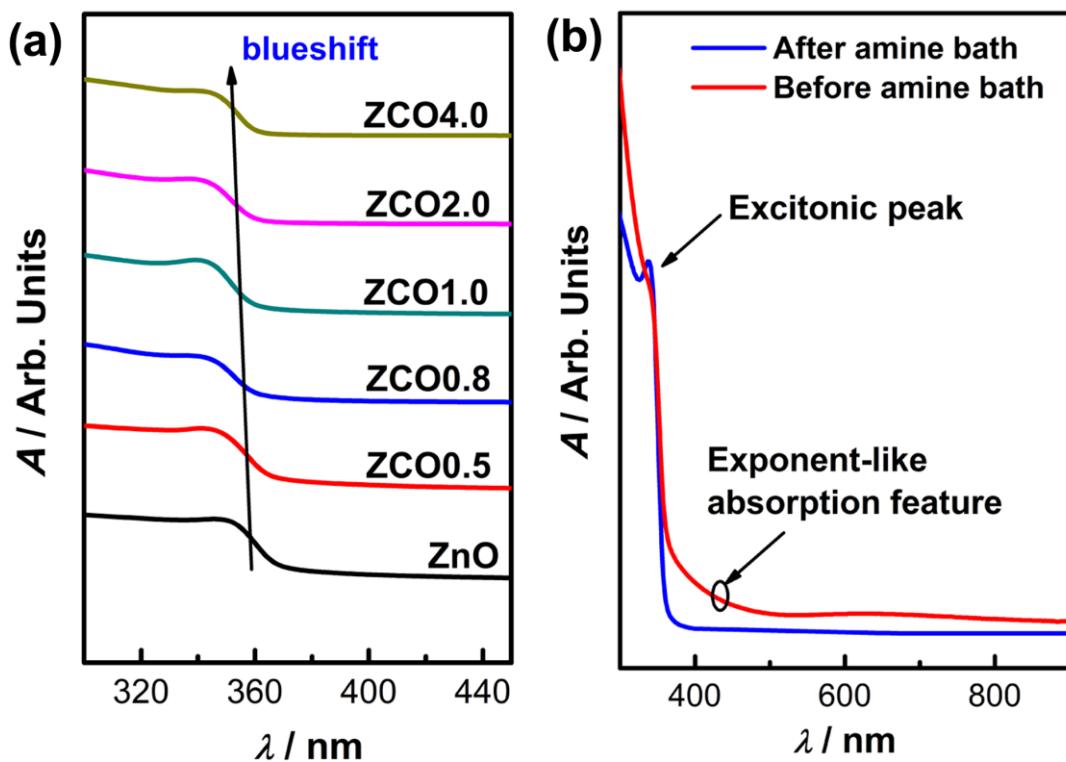
**Fig. S3** XRD data of as-prepared ZnO:Cu NCs (a) before and (b) after amine bath treatment. In each figure, on the right panel, a continuous shift of (002) diffraction peak was extracted for observing dopant-induced lattice expansion or contraction. After amine bath, the diffraction peak width slightly turns larger, which possibly stems from more dispersive NC distribution due to OA ligand modification.

**Table S2.** Detailed XRD refinement result from Rietveld Analysis Program (Orion Software)

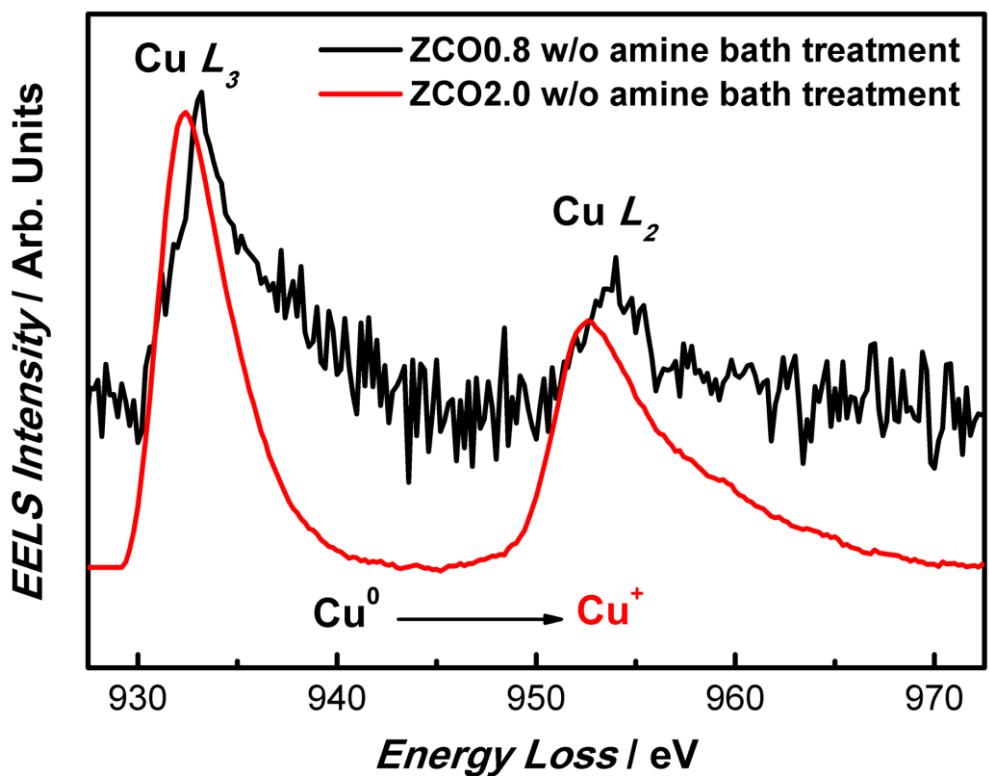
	Doping amount/ at.%	$d(002)/\text{\AA}$	$d(101)/\text{\AA}$	$a/\text{\AA}$	$c/\text{\AA}$
ZnO:Cu NCs without amine bath	0	2.603(4)	2.475(7)	3.246(6)	5.206(9)
	0.5	2.603(7)	2.475(9)	3.249(5)	5.207(5)
	0.8	2.607(9)	2.478(4)	3.254(1)	5.215(9)
	1.0	2.611(0)	2.483(0)	3.259(2)	5.221(9)
	2.0	2.611(9)	2.484(2)	3.260(9)	5.223(8)
	4.0	2.616(1)	2.489(3)	3.268(0)	5.232(1)
ZnO:Cu NCs with amine bath	0	2.603(8)	2.475(4)	3.248(9)	5.207(6)
	0.5	2.602(9)	2.469(6)	3.239(4)	5.205(7)
	0.8	2.602(3)	2.469(3)	3.239(1)	5.204(5)
	1.0	2.600(9)	2.468(7)	3.238(6)	5.201(8)
	2.0	2.597(6)	2.467(9)	3.238(4)	5.195(2)
	4.0	2.588(6)	2.466(7)	3.239(1)	5.177(1)



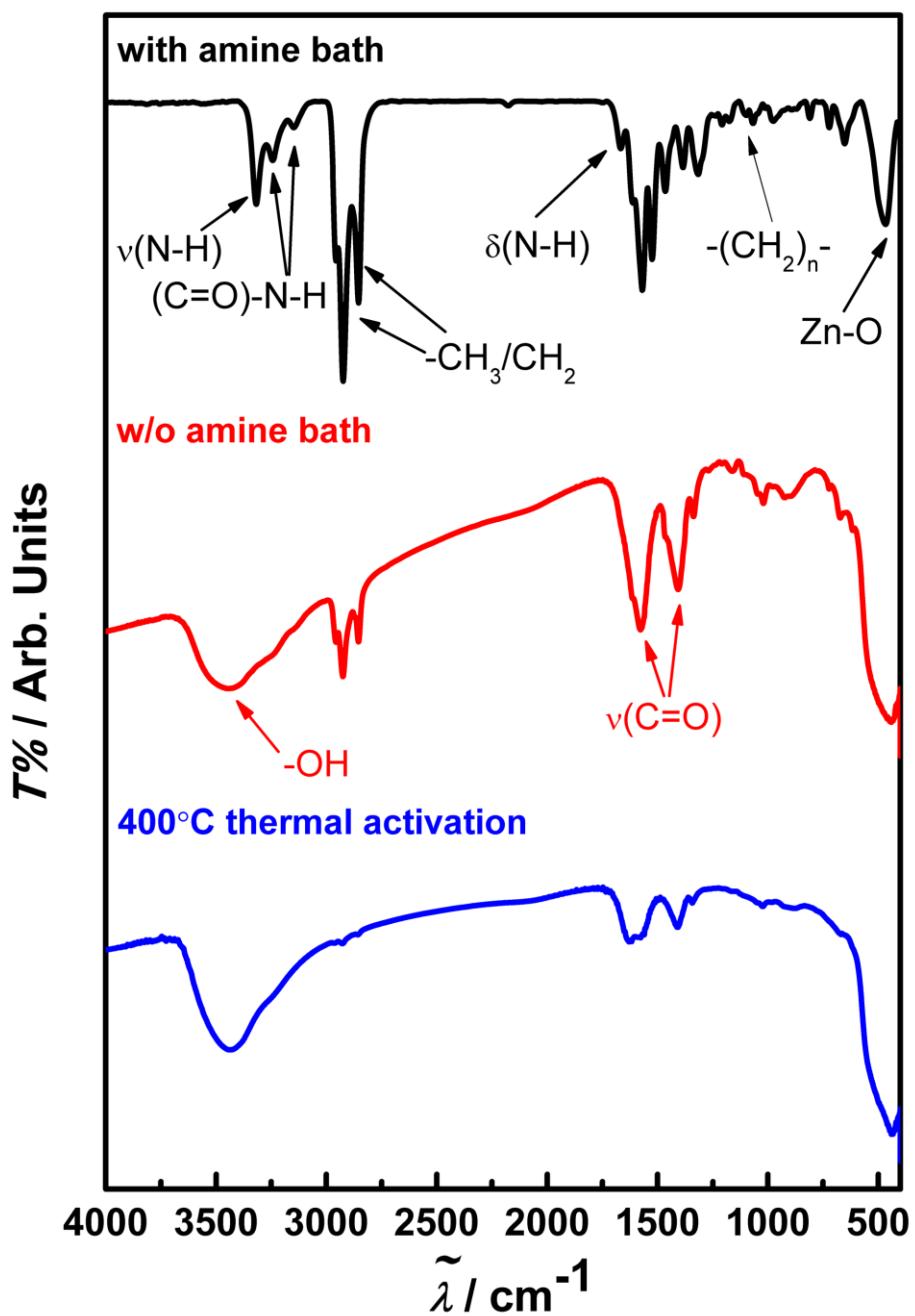
**Fig. S4** EELS reference signals collected from home-made pure-phase Cu,  $\text{Cu}_2\text{O}$  and  $\text{CuO}$  nanoparticles.



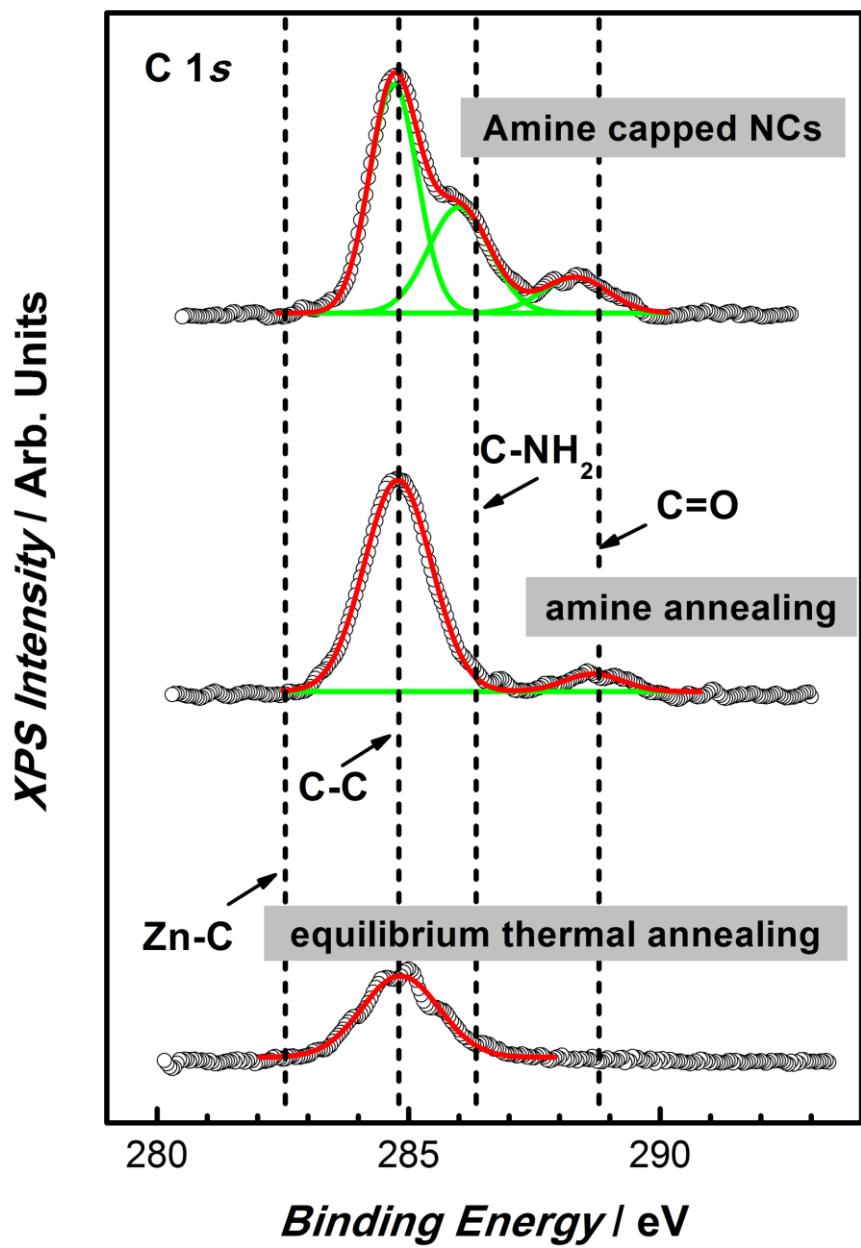
**Fig. S5** (a) Dopant concentration-dependent excitonic absorption spectra. (b) An absorption spectral comparison of ZCO0.8 samples before and after amine bath treatment. Exponent-like feature of absorption spectrum in the whole visible range of NCs without amine bath indicates a sort of continuous energy-level structure, supportive of the presence of atomic Cu metal. Through amine bath processing, this band-like structure will disappear, implying the transformation of copper atom local environment.



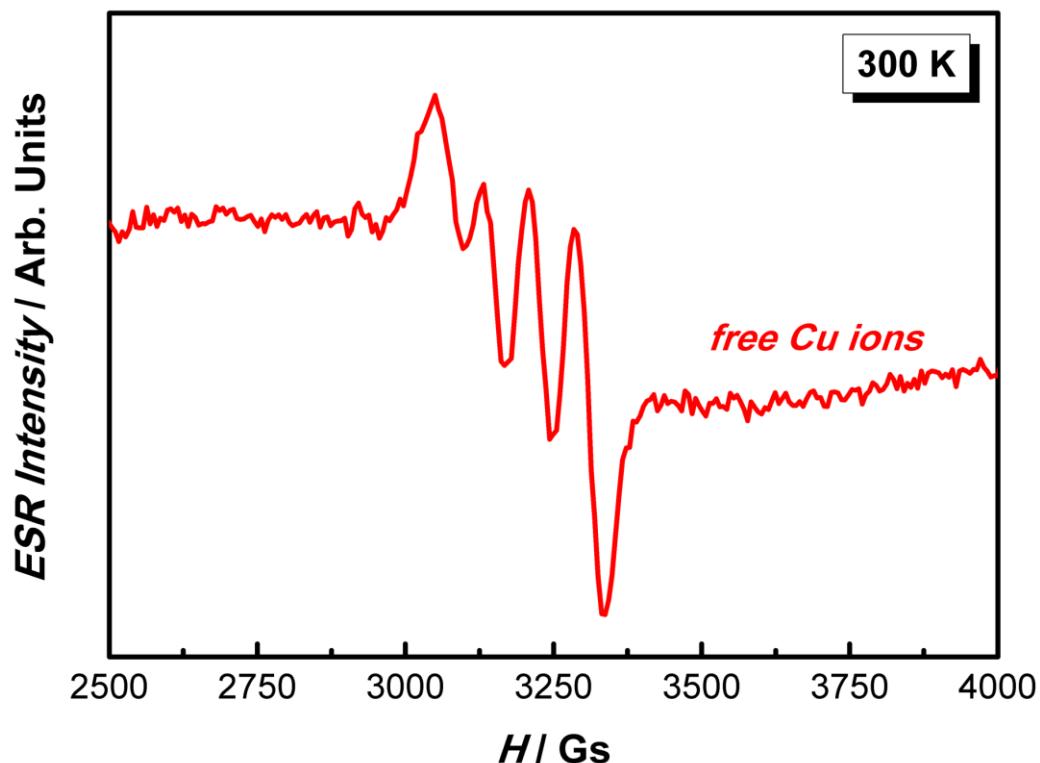
**Fig. S6** The Cu  $L_{3,2}$  core-loss EELS comparison between amine-bath-untreated lightly-doped (0.8%) and heavily-doped (2.0%) samples.



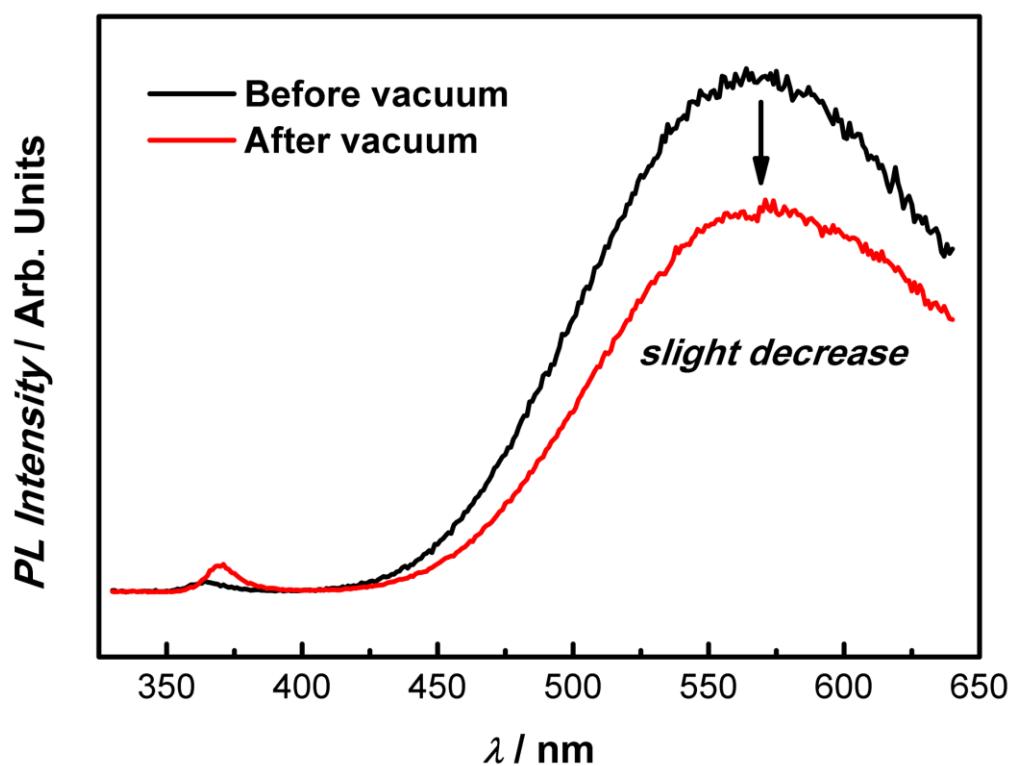
**Fig. S7** A series of FT-IR spectra recorded from amine-bath-treated, amine-bath-untreated and amine-annealed ZCO4.0 NCs. The disappearance of O–H stretching vibration in amine-bath-treated sample indicates a charge transfer interaction between donor-like hydroxyl and Cu acceptor. Not only this, with ligand thermal decomposition at 400°C, all amine molecule related vibrations have disappeared, indicating N atoms have diffused into the bulk of ZnO:Cu.



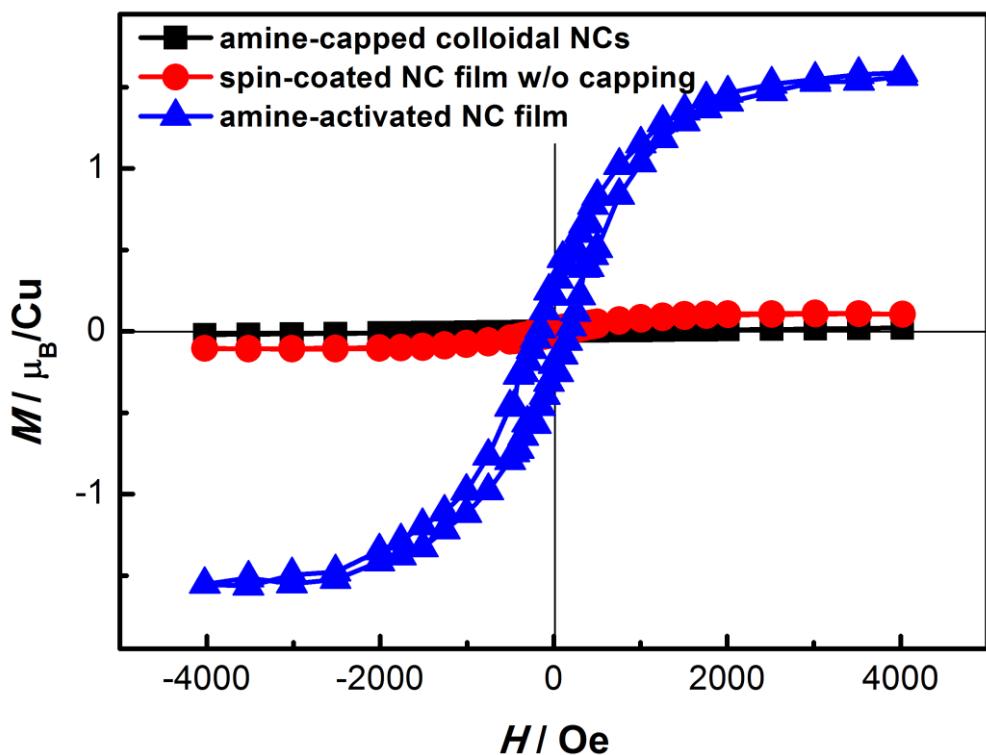
**Fig. S8** The corresponding variation of C 1s XPS binding environment in ZCO4.0 NCs processed by different conditions. For different samples, the aim of element analysis is distinct. C 1s analysis of both amine-processed samples should be done only on the surface part. Since OA molecules have diffused into the bulk in annealing, surface C-N bonds should be non-available, which has been confirmed by this figure. Different from the above samples, the one annealed at 600°C in equilibrium was scanned after  $\text{Ar}^+$  ions surface etching (etching depth ca.10 nm) in order to monitor possible carbon contamination effect and exclude the possibility of Zn-C bond for FM contribution.



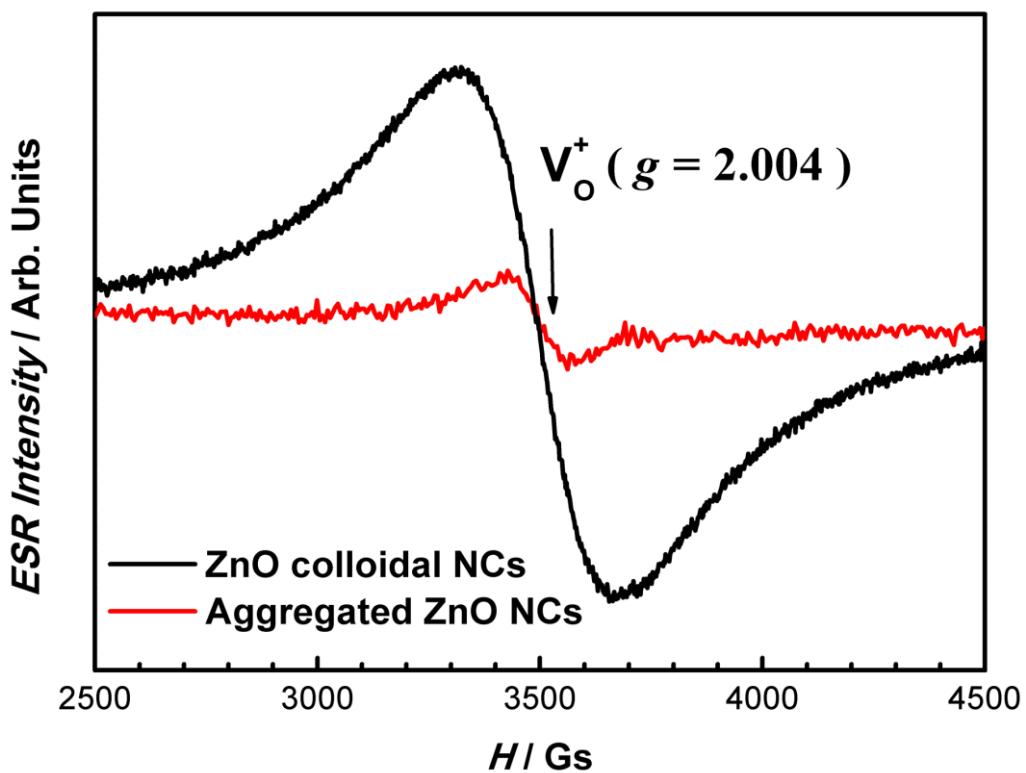
**Fig. S9** Room-temperature ESR signal of free diluted  $\text{Cu}^{2+}$  ions in chloroform solution.



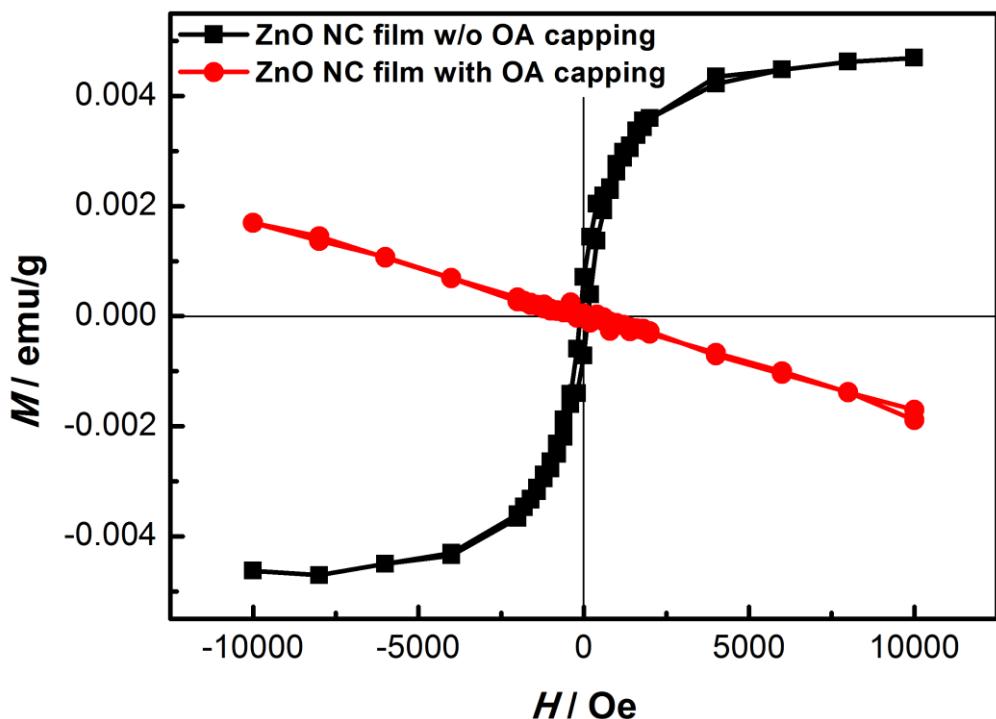
**Fig. S10** The comparison of 300 K PL spectra recorded from N-capped ZnO nanocrystalline film before and after vacuum treatment.



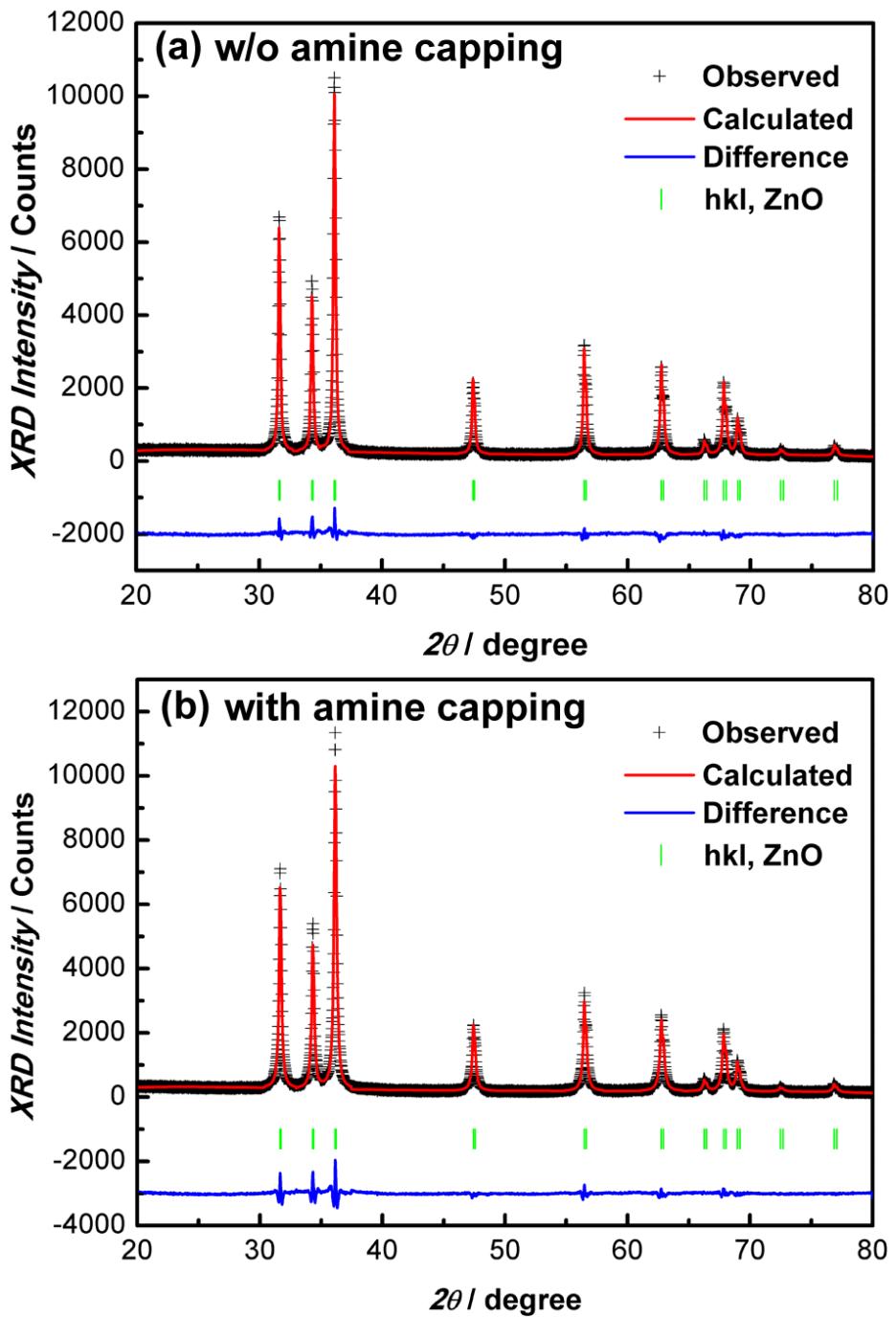
**Fig. S11** 300 K magnetization from OA-capped 0.2% Cu-doped ZnO colloidal NCs, a spin-coated NC film without OA capping, annealed at 400°C, and the same NC film with OA capping. All data have been corrected for a diamagnetic background.



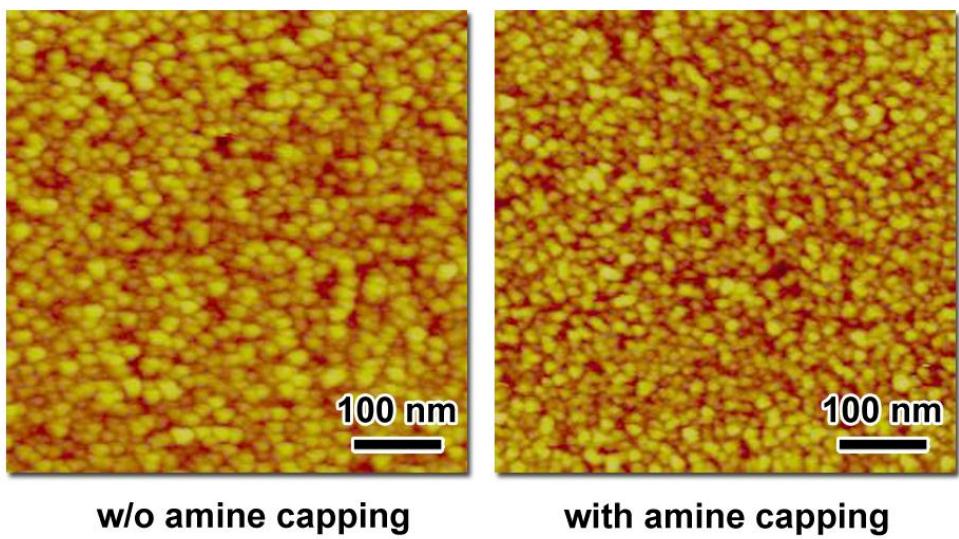
**Fig. S12** 300 K ESR signals of pure ZnO NCs (without OA capping) before and after aggregation.



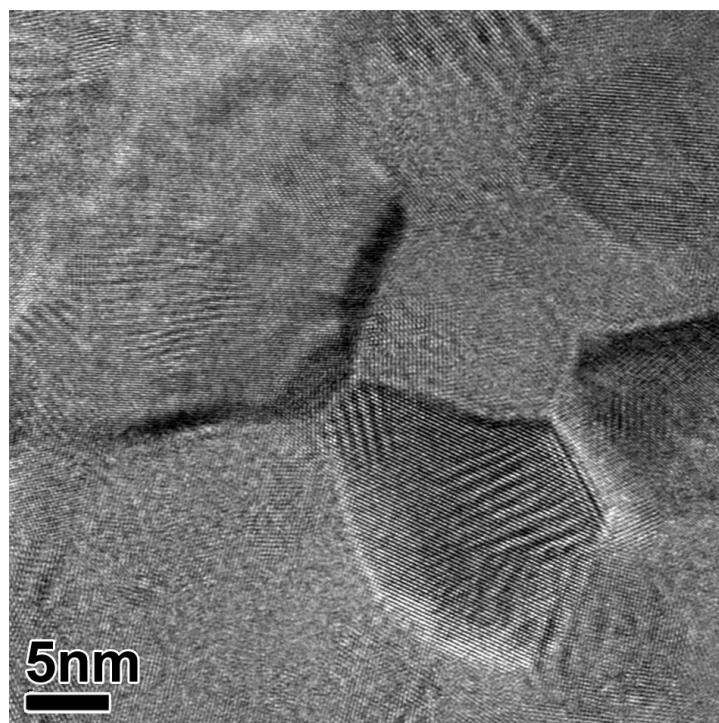
**Fig. S13** 300 K magnetization contrast between spin-coated ZnO NC film before and after OA capping, annealed at 400°C. Evidently,  $d^0$ -FM can be totally compensated under the presence of OA ligands.



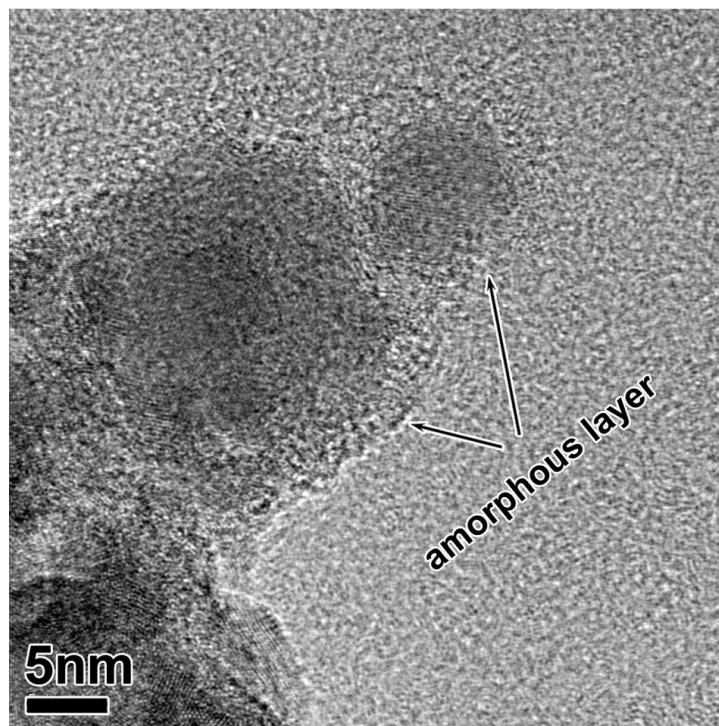
**Fig. S14** The effect of amine-capping on texture in 400°C annealed 0.2% Cu-doped ZnO nanocrystalline film.



**Fig. S15** The effect of amine-capping on grain-size in 400°C annealed 0.2% Cu-doped ZnO nanocrystalline film.



w/o amine capping



with amine capping

**Fig. S16** The effect of amine-capping on amorphous layer in 400°C annealed 0.2% Cu-doped ZnO nanocrystalline film.

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